

Quadruple Operational Amplifiers

DESCRIPTION

The LMx24 consists of four independent, high gain, internally frequency compensated operational amplifiers which were designed specifically to operate from a single power supply over a wide range of voltages. Operation from split power supplies is also possible and the low power supply current drain is independent of the magnitude of the power supply voltage. Application areas include transducer amplifiers, DC gain blocks and all the

conventional op amp circuits.

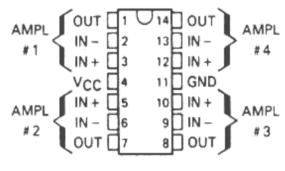
FEATURES

- Wide range of supply voltages
- Low supply current drain independent of supply voltage
- Low input biasing current
- Low input offset voltage and offset current
- Input common-mode voltage range includes ground
- Differential input voltage range equal to the power supply voltage
- DC voltage gain 100 V/ mV Typ
- Internally frequency compensation

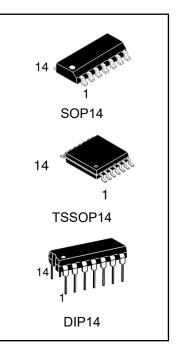
ORDERING INFORMATION

DEVICE	Package Type	MARKING	Packing	Packing Qty
LM324N	DIP14	LM 324	TUBE	1000/box
LM224N	DIP14	LM 224	TUBE	1000/box
LM324M/TR	SOP14	LM 324	REEL	2500/reel
LM224M/TR	SOP14	LM 224	REEL	2500/reel
LM324MT/TR	TSSOP14	LM 324	REEL	2500/reel
LM224MT/TR	TSSOP14	LM 224	REEL	2500/reel

PACKAGE INFORMATION



DIP14/SOP14/TSSOP14





ELECTRICAL CHARACTERISTICS

at specified free-air temperature, VCC = 5V (unless otherwise noted)

DADAMETED	TEST COL		LM224				
PARAMETER	TEST COI	NDITIONS*	MIN	TYP	MAX	UNIT	
VIO Input offset voltage	Vcc =5V to MAX, VIC = VICR min, VO=1.4V	25℃ Full temperature range		3	7 9	mV	
αVIO Average temperature coefficient of input offsetvoltage		Full temperature range		7		µV/℃	
IIO Input offset current	Vo=1.4V	25℃ Full temperature range		2	50 150	nA	
αIIO Average temperature coefficient of input offsetcurrent		Full temperature range		10		pA/ ℃	
liB	Vo=1.4V	25 ℃		-20	-250	nA	
Input bias current	V0-1.4V	Full temperature range			-500		
VICR	Vcc = 5V to MAX	25 ℃	0 to Vcc-1.5			V	
Common-mode input voltage range		Full temperature range	0 to Vcc - 2				
	RL = 2 kΩ	25 ℃	Vcc-1.5				
VOH	Vcc = MAX, RL =2kΩ	Full temperature range	26			V	
High-level output voltage	Vcc = MAX, RL = 10 kΩ	Full temperature range	27	28			
VOL Low-level output voltage	RL = 10 kΩ	Full temperature range		5	20	mV	
AVD	Vcc = 15 V,	25 ℃	25	100		.,, .,	
Large-signal differential voltage amplification	Vo=1V to 11 V, RL ≥ 2 kΩ	Full temperature range	15			V/mV	
CMRR Common-mode rejection ratio	Vcc = 5V to MAX, VIC = VICR min	25 ℃	65	80		dB	
kSVR Supply voltage rejection ratio (aVcc/aVIO)	Vcc = 5V to MAX	25 ℃	65	100		dB	
Vo1/Vo2 Crosstalk attenuation	f=1kHz to 20 kHz	25 ℃		120		dB	
	Vcc = 15 V,	25 °C	-20	-30		mA	
	VID=1V,Vo= 0	Full temperature range	-10				
lo	Vcc = 15 V,	25 °C	10	20			
Output current	VID= -1V, Vo=15V	Full temperature range	5				
	VID= -1V, Vo = 200 mV	25 ℃	12	30		μA	



LM224/324

los Short-circuit output current	Vcc at 5 V, GND at -5V,Vo=0	25 ℃	±40	±60	mA
lcc	Vo = 2.5 V, No load	Full temperature range	1.5	2.4	
Supply current (four amplifiers)	Vcc = MAX, Vo = 0.5Vcc, Noload	Full temperature range	1.1	3	mA

* All characteristics are measured under open loop conditions with zero common-mode input voltage unless otherwise specified.

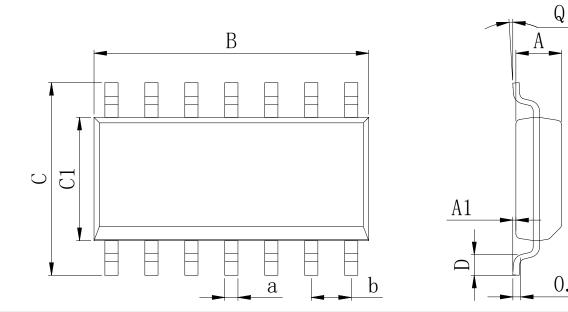
"MAX" Vcc for testing purposes is 30 V. LM224 Operating temperature -40 - 85° C, LM324 Operating temperature 0 - 70° C, MAX Junction temperature + 125°C.



0.25

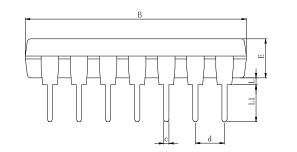
Physical Dimensions

SOP14

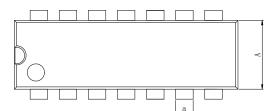


Dimensions In Millimeters(SOP14)										
Symbol:	A	A1	В	С	C1	D	Q	а	b	
Min:	1.35	0.05	8.55	5.80	3.80	0.40	0°	0.35	1.27 PSC	
Max:	1.55	0.20	8.75	6.20	4.00	0.80	8°	0.45	1.27 BSC	

DIP14

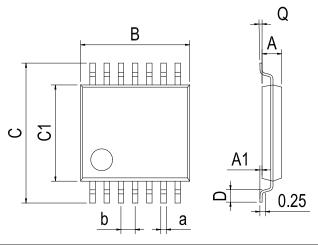






Dimensions In Millimeters(DIP14)										
Symbol:	A	В	D	D1	Е	L	L1	а	с	d
Min:	6.10	18.94	8.40	7.42	3.10	0.50	3.00	1.50	0.40	2.54 BSC
Max:	6.68	19.56	9.00	7.82	3.55	0.70	3.60	1.55	0.50	2.34 830





Dimensions In Millimeters(TSSOP14)										
Symbol:	А	A1	В	С	C1	D	Q	а	b	
Min:	0.85	0.05	4.90	6.20	4.30	0.40	0°	0.20	0.65 BSC	
Max:	0.95	0.20	5.10	6.60	4.50	0.80	8°	0.25	0.05 630	

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